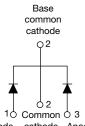


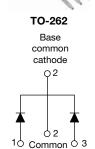
Vishay Semiconductors

Schottky Rectifier, 2 x 20 A



D²PAK





Anode cathode Anode

Anode cathode Anode

VS-40CTQ150-1PbF

PRODUCT SUMMARY	
Package	TO-262AA, TO-263AB (D ² PAK)
I _{F(AV)}	2 x 20 A
V _R	150 V
V _F at I _F	0.71 V
I _{RM}	15 mA at 125 °C
T _J max.	175 °C
Diode variation	Common cathode
E _{AS}	1 mJ

FEATURES

- AEC-Q101 qualified
- Very low forward voltage drop
- Halogen-free according to IEC 61249-2-21
 definition
- 175 °C T_J operation
- Center tap TO-220 package
- High frequency operation
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- Guard ring for enhanced ruggedness and long term reliability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 $^\circ\mathrm{C}$
- Compliant to RoHS Directive 2002/95/EC

DESCRIPTION

The VS-40CTQ... center tap Schottky rectifier has been optimized for very low forward voltage drop, with moderate leakage. The proprietary barrier technology allows for reliable operation up to 175 °C junction temperature. Typical applications are in switching power supplies, converters, freewheeling diodes, and reverse battery protection.

MAJOR RATINGS AND CHARACTERISTICS					
SYMBOL	CHARACTERISTICS	VALUES	UNITS		
I _{F(AV)}	Rectangular waveform	40	А		
V _{RRM}		150	V		
I _{FSM}	t _p = 5 μs sine	1500	А		
V _F	20 Apk, $T_J = 125 \text{ °C}$ (per leg)	0.71	V		
TJ		- 55 to 175	°C		

VOLTAGE RATINGS				
PARAMETER	SYMBOL	VS-40CTQ150SPbF VS-40CTQ150-1PbF	UNITS	
Maximum DC reverse voltage	V _R	150	V	
Maximum working peak reverse voltage	V _{RWM}	150	v	



COMPLIANT HALOGEN

Vishay Semiconductors

Schottky Rectifier, 2 x 20 A



ABSOLUTE MAXIMUM RATING	S				
PARAMETER	SYMBOL	TEST COND	ITIONS	VALUES	UNITS
Maximum average per leg		$_{E(AV)}$ 50 % duty cycle at T _C = 140 °C, rectangular waveform		20	
See fig. 5 per device	I _{F(AV)}		, rectangular wavelonn	40 A	
Maximum peak one cycle non-repetitive surge current per leg		5 µs sine or 3 µs rect. pulse	Following any rated load condition and with rated	1500	~
See fig. 7	I _{FSM}	10 ms sine or 6 ms rect. pulse	V _{RRM} applied	250	
Non-repetitive avalanche energy per leg	E _{AS}	$T_J = 25 \ ^{\circ}C, \ I_{AS} = 1.5 \ A, \ L = 0.9$	mH	1.0	mJ
Repetitive avalanche current per leg	I _{AR}	Current decaying linearly to zer Frequency limited by T _J maxim	•	1.5	A

ELECTRICAL SPECIFICATIONS					
PARAMETER	SYMBOL	TEST CO	NDITIONS	VALUES	UNITS
		20 A	T - 25 °C	0.93	
Maximum forward voltage drop per leg	V _{FM} ⁽¹⁾	40 A	T _J = 25 °C	1.16	v
See fig. 1	VFM	20 A	T 105 %O	0.71	
		40 A	T _J = 125 °C	0.85	
Maximum reverse leakage current per leg	I _{RM} ⁽¹⁾	$T_J = 25 \ ^\circ C$		50	μA
See fig. 2		T _J = 125 °C	V _R = Rated V _R	15	mA
Maximum junction capacitance per leg	CT	$V_{R} = 5 V_{DC}$ (test signal range	ge 100 kHz to 1 MHz), 25 °C	450	pF
Typical series inductance per leg	LS	Measured lead to lead 5 r	nm from package body	8.0	nH
Maximum voltage rate of change	dV/dt	Rated V _R		10 000	V/µs

Note

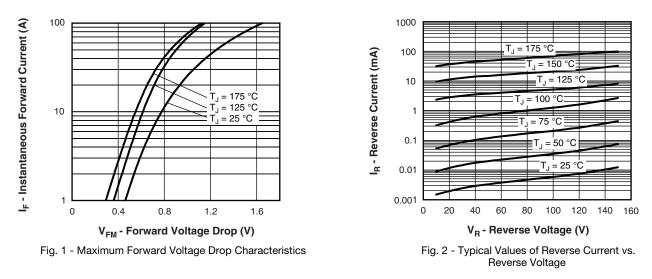
 $^{(1)}\,$ Pulse width < 300 $\mu s,$ duty cycle < 2 %

THERMAL - MECHANI		CIFICAT	IONS		
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum junction and storage temperature range		T _J , T _{Stg}		- 55 to 175	°C
Maximum thermal resistance, junction to case per leg		D	DC operation See fig. 4	1.5	
Maximum thermal resistance, junction to case per package		R _{thJC}	DC operation	0.75	°C/W
Typical thermal resistance, case to heatsink		R _{thCS}	Mounting surface, smooth and greased	0.5	
Approvimete weight				2	g
Approximate weight				0.07	oz.
Manuation to your	minimum			6 (5)	kgf ⋅ cm
Mounting torque	maximum		Non-lubricated threads	12 (10)	(lbf · in)
Marking davias			Case style D ² PAK	40CT0	Q150S
Marking device			Case style TO-262	40CTC	2150-1



Schottky Rectifier, 2 x 20 A

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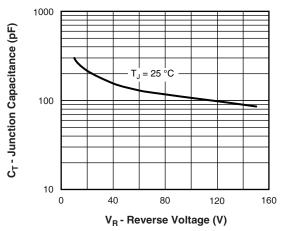


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

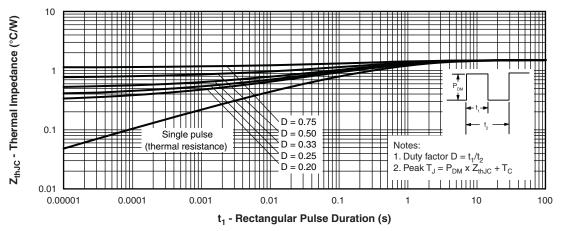


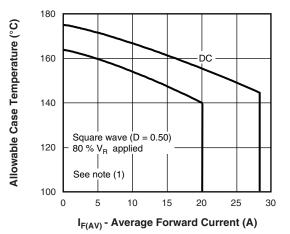
Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics

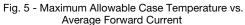
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Schottky Rectifier, 2 x 20 A

Average Power Loss (W)







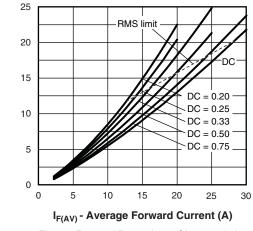


Fig. 6 - Forward Power Loss Characteristics

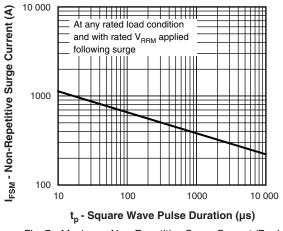


Fig. 7 - Maximum Non-Repetitive Surge Current (Per Leg)

Note

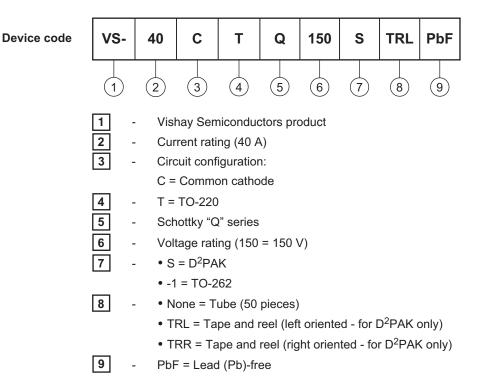
⁽¹⁾ Formula used: $T_C = T_J - (Pd + Pd_{REV}) \times R_{thJC}$; Pd = Forward power loss = $I_{F(AV)} \times V_{FM}$ at ($I_{F(AV)}/D$) (see fig. 6); Pd_{REV} = Inverse power loss = $V_{R1} \times I_R (1 - D)$; I_R at V_{R1} = 80 % V_R applied



Schottky Rectifier, 2 x 20 A

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ORDERING INFORMATION TABLE



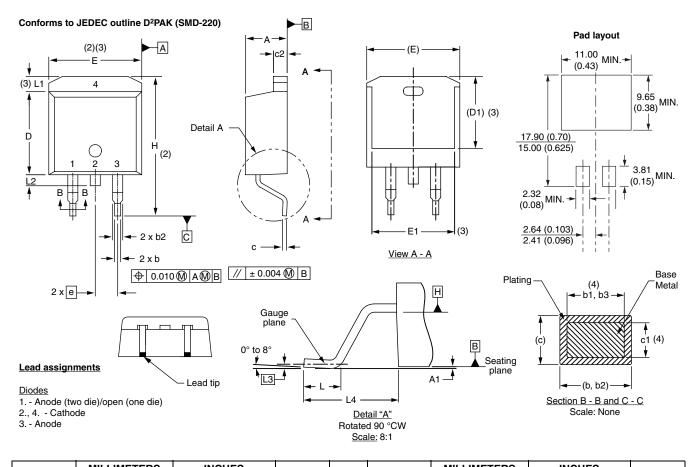
LINKS TO RELATED DOCUMENTS				
Dimensions	www.vishay.com/doc?95014			
Part marking information	www.vishay.com/doc?95008			
Packaging information	www.vishay.com/doc?95032			
SPICE model	www.vishay.com/doc?95434			

Vishay High Power Products

D²PAK, TO-262

DIMENSIONS FOR D²PAK in millimeters and inches

SHA



SYMBOL	MILLIM	ETERS	INC	HES	NOTES
STMBOL	MIN.	MAX.	MIN.	MAX.	NOTES
A	4.06	4.83	0.160	0.190	
A1	0.00	0.254	0.000	0.010	
b	0.51	0.99	0.020	0.039	
b1	0.51	0.89	0.020	0.035	4
b2	1.14	1.78	0.045	0.070	
b3	1.14	1.73	0.045	0.068	4
с	0.38	0.74	0.015	0.029	
c1	0.38	0.58	0.015	0.023	4
c2	1.14	1.65	0.045	0.065	
D	8.51	9.65	0.335	0.380	2

SYMBOL	MILLIM	ETERS	INC	HES	NOTES
STMBOL	MIN.	MAX.	MIN.	MAX.	NOTES
D1	6.86	8.00	0.270	0.315	3
E	9.65	10.67	0.380	0.420	2, 3
E1	7.90	8.80	0.311	0.346	3
е	2.54 BSC		0.100	BSC	
Н	14.61	15.88	0.575	0.625	
L	1.78	2.79	0.070	0.110	
L1	-	1.65	-	0.066	3
L2	1.27	1.78	0.050	0.070	
L3	0.25 BSC		0.010	BSC	
L4	4.78	5.28	0.188	0.208	

⁽⁷⁾ Outline conforms to JEDEC outline TO-263AB

Notes

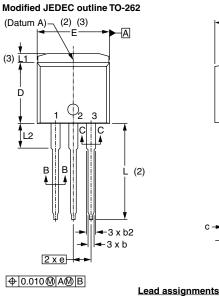
- ⁽¹⁾ Dimensioning and tolerancing per ASME Y14.5 M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- $^{(3)}\,$ Thermal pad contour optional within dimension E, L1, D1 and E1
- ⁽⁴⁾ Dimension b1 and c1 apply to base metal only
- ⁽⁵⁾ Datum A and B to be determined at datum plane H
- ⁽⁶⁾ Controlling dimension: inch

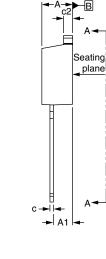
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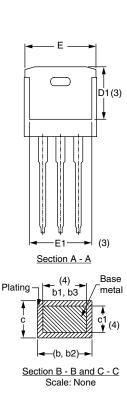
D²PAK, TO-262



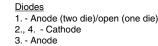
DIMENSIONS FOR TO-262 in millimeters and inches







Lead tip



SYMBOL	MILLIM	MILLIMETERS		INCHES		
	MIN.	MAX.	MIN.	MAX.	NOTES	
А	4.06	4.83	0.160	0.190		
A1	2.03	3.02	0.080	0.119		
b	0.51	0.99	0.020	0.039		
b1	0.51	0.89	0.020	0.035	4	
b2	1.14	1.78	0.045	0.070		
b3	1.14	1.73	0.045	0.068	4	
С	0.38	0.74	0.015	0.029		
c1	0.38	0.58	0.015	0.023	4	
c2	1.14	1.65	0.045	0.065		
D	8.51	9.65	0.335	0.380	2	
D1	6.86	8.00	0.270	0.315	3	
E	9.65	10.67	0.380	0.420	2, 3	
E1	7.90	8.80	0.311	0.346	3	
е	2.54	BSC	0.100	BSC		
L	13.46	14.10	0.530	0.555		
L1	-	1.65	-	0.065	3	
L2	3.56	3.71	0.140	0.146		

Notes

- ⁽¹⁾ Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- ⁽³⁾ Thermal pad contour optional within dimension E, L1, D1 and E1

⁽⁴⁾ Dimension b1 and c1 apply to base metal only

⁽⁵⁾ Controlling dimension: inches

⁽⁶⁾ Outline conform to JEDEC TO-262 except A1 (maximum), b (minimum) and D1 (minimum) where dimensions derived the actual package outline

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